PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kouhei TANIGUCHI	10/24/2011
Takayuki MATSUZAKI	10/27/2011
Shinya KATOU	10/28/2011
Kouji KOMORIDA	10/24/2011
Michio MASHINO	10/24/2011
Tatsuya SAKUTA	10/24/2011
Rie KATOU	10/24/2011

RECEIVING PARTY DATA

Name:	Hitachi Chemical Company, Ltd.
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City:	Shinjuku-ku, Tokyo
State/Country:	JAPAN
Postal Code:	163-0449

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13274288

CORRESPONDENCE DATA

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REEL: 027474 FRAME: 0443

PATENT 501774751

NAME OF SUBMITTER:	Dawn Minter
Total Attachments: 2 source=assignment#page1.tif source=assignment#page2.tif	

PATENT REEL: 027474 FRAME: 0444

ASSIGNMENT

Whereas, I/we, Name **Address** c/o HITACHI CHEMICAL COMPANY, LTD., 1) Kouhei TANIGUCHI 14 Goiminamikaigan, lchihara-shi, Chiba 290-8567 Japan CO HITACHI CHEMICAL COMPANY, LTD., Takayuki MATSUZAKI 14 Goiminamikaigan, Ichihara-shi, Chiba 290-8567 Japan C/O HITACHI CHEMICAL COMPANY, LTD., 3) Shinya KATOU 14 Goiminamikaigan, Ichihara-shi, Chiba 290-8567 Japan do HITACHI CHEMICAL COMPANY, LTD., Kouji KOMORIDA 14 Goiminamikaigan, Ichihara-shi, Chiba 290-8567 Japan C/O HITACHI CHEMICAL COMPANY, LTD., Michio MASHINO 14 Goiminamikaigan, Ichihara-shi, Chiba 290-8567 Japan C/O HITACHI CHEMICAL COMPANY, LTD., Tatsuya SAKUTA 14 Goiminamikaigan, Ichihara-shi, Chiba 290-8567 Japan c/o HITACHI CHEMICAL COMPANY, LTD., Rie KATOU 14 Goiminamikaigan, Ichihara-shi, Chiba 290-8567 Japan hereinafter called assignor(s), have invented certain improvements in WAFER PROCESSING TAPE, METHOD OF MANUFACTURING WAFER PROCESSING TAPE, AND METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below: October 14,2011____, Serial No. filed on Whereas HITACHI CHEMICAL COMPANY, LTD. 1-1, Nishi-Shinjuku 2-chome, Shinjuku-ku, Tokyo 163-0449 Japan (assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor: NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment; AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

	INVENTORS	DATE SIGNED
1):	<u> </u>	Oct. 24. 2011
Name:	Kouhei TANIGUCHI	
2):	松战降行	Oct 27 2011
Name:	Takayuki MATSUZAKI	000.27, 2011

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)

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3): Name:	Po 基と Shinya KATOU	Oct. 28, 2011
4): Name:	V存t的	Oct. 24,2011
5): Name:	一	001.24.2011
6): Name:	Tatsuya SAKUTA	Oct. 24, 2011
7): Name:	P 是 表 子里希	Oct. 24, 2011

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)